

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT6190751

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HWIDEUK LEE	06/16/2020
YANGSIK LEE	06/16/2020
YONGCHAN PARK	06/16/2020
SUNGSU HAN	06/16/2020
RECEIVING PARTY DATA	
Name:	LG DISPLAY CO., LTD.
Street Address:	128, YEQUI-DAERO, YEONGDEUNGPO-GU
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	07336
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16922390
CORRESPONDENCE DATA	
Fax Number:	(703)205-8050
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	7032058000
Email:	mailroom@bskb.com, brian.mukuria@bskb.com
Correspondent Name:	BIRCH STEWART KOLASCH & BIRCH LLP
Address Line 1:	8110 GATEHOUSE ROAD, SUITE 100 EAST
Address Line 4:	FALLS CHURCH, VIRGINIA 22042-1248
ATTORNEY DOCKET NUMBER:	6588-0201PUS1
NAME OF SUBMITTER:	BRIAN MUKURIA
SIGNATURE:	/Brian Mukuria/
DATE SIGNED:	07/08/2020
Total Attachments: 2	
source=2020-07-08 ASSIGNMENT 6588-0201PUS1#page1.tif	
source=2020-07-08 ASSIGNMENT 6588-0201PUS1#page2.tif	

I hereby authorize and request the United States Patent and Trademark Office and officials in patent offices in foreign countries to issue any and all of said Letters Patent to the ASSIGNEE as the assignee of my entire right, title, and interest in and to the same, for the sole use and benefit of the ASSIGNEE, and its lawful successors and assigns, to the full end of the term for which said Letters Patent may be granted.

I hereby grant the attorney of record the power to insert on this Assignment any further identification that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office or other authority for recordation of this document.

I hereby covenant that I have the full right to convey the interest assigned by this Assignment, and I have not executed and will not execute any agreement in conflict with this Assignment; and

Further, I hereby further covenant and agree that I will, without further consideration, communicate with the ASSIGNEE, and its lawful successors and assigns, any facts known to me respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said ASSIGNEE, and its lawful successors or assigns, execute all divisional, continuation, continuation-in-part, and reissue applications, make all rightful oaths and generally do everything possible to aid the ASSIGNEE, and its lawful successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the ASSIGNEE, and its lawful successors and assigns.

IN TESTIMONY WHEREOF, I have hereunto set my hands.

NAME OF INVENTOR (Full Legal Name): HwiDeuk LEE

Signature: HwiDeuk LEE Date: 2020-06-16

NAME OF INVENTOR (Full Legal Name): Yangsik LEE

Signature: Yangsik LEE Date: 2020-06-16

NAME OF INVENTOR (Full Legal Name): YongChan PARK

Signature: YongChan Park Date: 2020-06-16

NAME OF INVENTOR (Full Legal Name): Sungsu HAN

Signature: Sungsu HAN Date: 2020-06-16

Birch, Stewart, Kolasch & Birch, LLP